IRF9620

Vishay Siliconix



TO-220AB

PRODUCT SUMMARY

V_{DS} (V)

R_{DS(on)} (Ω) Q_q max. (nC)

Q_{gs} (nC)

Q_{gd} (nC)

Configuration

G C

 $V_{GS} = -10 V$

P-Channel MOSFET

1.5

-200

22

12

10

Single

Power MOSFET

FEATURES

- Dynamic dV/dt rating
- P-channel
- Fast switching
- Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Note

* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free	IRF9620PbF			
Lead (Pb)-free and halogen-free	IRF9620PbF-BE3			

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unle	ess otherwis	e noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	-200	V	
Gate-source voltage			V _{GS}	± 20	V V	
Continuous drain surrent	V _{GS} at -10 V	T _C = 25 °C	- I _D	-3.5		
Continuous drain current		T _C = 100 °C		-2.0	А	
Pulsed srain current ^a			I _{DM}	-14		
Linear serating factor				0.32	W/°C	
Maximum power dissipation	T _C = 25 °C		PD	40	W	
Peak diode recovery dV/dt ^b			dV/dt	-5.0	V/ns	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Soldering recommendations (peak temperature) ^c	For 10 s			300	7 0	
Mounting torque	6-32 or M3 screw			10	lbf ∙ in	
Mounting torque				1.1	N · m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. $I_{SD} \le -3.5$ A, dl/dt ≤ 95 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C

c. 1.6 mm from case

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Available



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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R _{thJA}	-	62	
Case-to-sink, flat, greased surface	R _{thCS}	0.50	-	°C/W
Maximum junction-to-case (drain)	R _{thJC}	-	3.1	

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V _{DS}	V _{GS} =	0 V, I _D = -250 μA	-200	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = -1 mA	-	-0.22	-	V/°C
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	V _{GS} , I _D = -250 μΑ	-2.0	-	-4.0	V
Gate-source leakage	I _{GSS}	١	/ _{GS} = ± 20 V	-	-	± 100	nA
Zana and an line alors a compact	1	V _{DS} =	-200 V, V _{GS} = 0 V	-	-	-100	μA
Zero gate voltage drain current	IDSS	V _{DS} = -160 V	′, V _{GS} = 0 V, T _J = 125 °C	-	-	-500	
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = -10 V$	I _D = -1.5 A ^b	-	-	1.5	Ω
Forward transconductance	9 _{fs}	V _{DS} = -	-50 V, I _D = -1.5 A ^b	1.0	-	-	S
Dynamic		•			•	•	
Input capacitance	C _{iss}		$V_{GS} = 0 V,$	-	350	-	
Output capacitance	C _{oss}	,	$V_{\rm DS} = -25 \rm V,$	-	100	-	pF
Reverse transfer capacitance	C _{rss}	f = 1.	0 MHz, see fig. 5	-	30	-	
Total gate charge	Qg			-	-	22	
Gate-source charge	Q _{gs}	$V_{GS} = -10 V$	I _D = -4.0 A, V _{DS} = -160 V, see fig. 11 and 18 ^b	-	-	12	nC
Gate-drain charge	Q _{gd}		See lig. 11 and 10	-	-	10	
Turn-on delay time	t _{d(on)}			-	15	-	
Rise time	t _r	V _{DD} = -	-100 V, I _D = -1.5 A,	-	25	-	
Turn-off delay time	t _{d(off)}	$R_{g} = 50 \ \Omega, R_{D} = 67 \ \Omega, \text{ see fig. 17 b} - 20 - $		-	ns		
Fall time	t _f			-	15	-	
Gate input resistance	R _g	f = 1 MHz, open drain		0.9	-	5.7	Ω
Internal drain inductance	L _D	Between lead.		-			
Internal source inductance	L _S			-	7.5	-	nH
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I _S	MOSFET syml showing the		-	-	-3.5	Α
Pulsed diode forward current ^a	I _{SM}	p - n junction diode		-	-	-14	
Body diode voltage	V _{SD}	T _J = 25 °C,	$I_{\rm S}$ = -3.5 A, $V_{\rm GS}$ = 0 V ^b	-	-	-7.0	V
Body diode reverse recovery time	t _{rr}	T - 25 °C I	250 d/d = 1000 d/c	-	300	450	ns
Body diode reverse recovery charge	Q _{rr}	$I_{J} = 25^{-1}$ C, $I_{F} =$	- 3.5 A, dl/dt = 100 A/μs ^b	-	1.9	2.9	μC
Forward turn-on time	t _{on}	Intrinsic tu	rn-on time is negligible (turn	-on is doi	ninated b	y L _S and	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width \leq 300 µs; duty cycle \leq 2 %

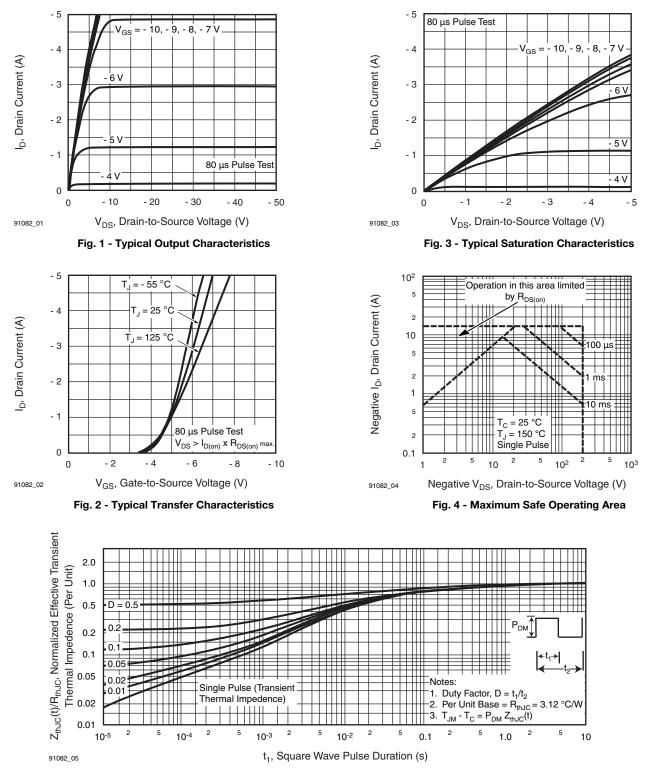
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



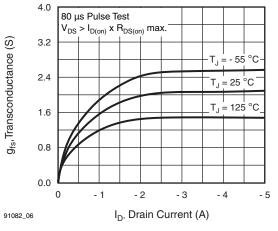


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Fig. 6 - Typical Transconductance vs. Drain Current

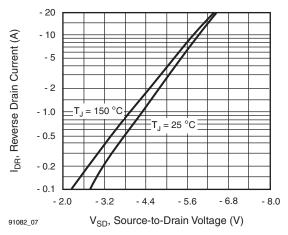


Fig. 7 - Typical Source-Drain Diode Forward Voltage

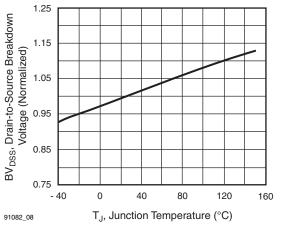


Fig. 8 - Breakdown Voltage vs. Temperature

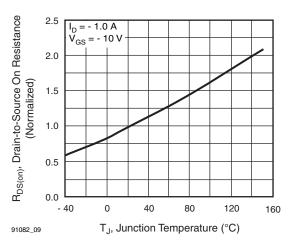


Fig. 9 - Normalized On-Resistance vs. Temperature

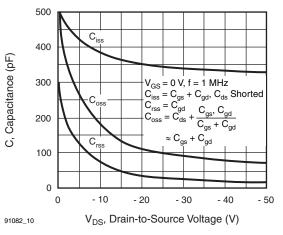


Fig. 10 - Typical Capacitance vs. Drain-to-Source Voltage

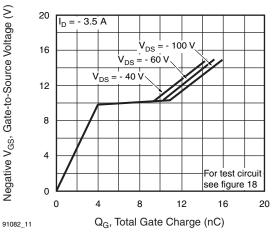


Fig. 11 - Typical Gate Charge vs. Gate-to-Source Voltage

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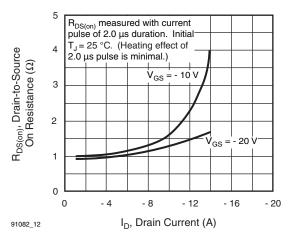


Fig. 12 - Typical On-Resistance vs. Drain Current

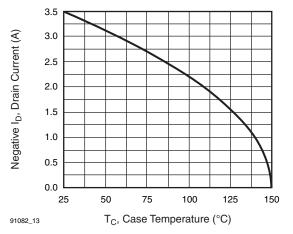


Fig. 13 - Maximum Drain Current vs. Case Temperature

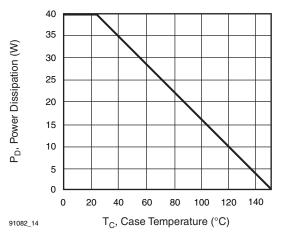


Fig. 14 - Power vs. Temperature Derating Curve

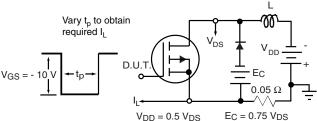


Fig. 15 - Clamped Inductive Test Circuit

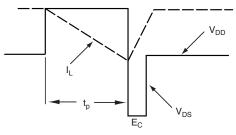


Fig. 16 - Clamped Inductive Waveforms

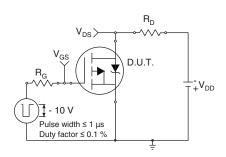


Fig. 17a - Switching Time Test Circuit

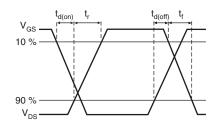


Fig. 17b - Switching Time Waveforms

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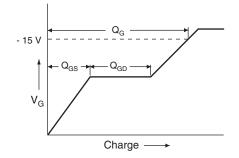
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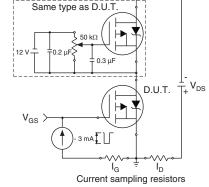
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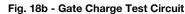






Current regulator

Fig. 18a - Basic Gate Charge Waveform



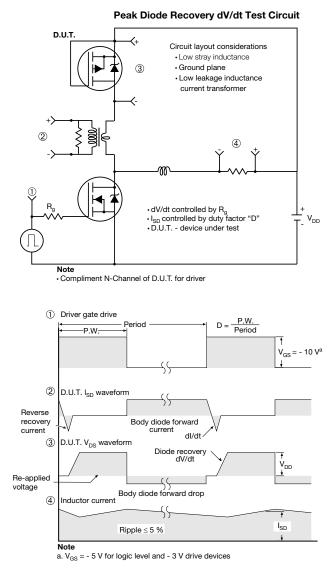


Fig. 19 - For P-Channel

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DIM.	MILLIN	METERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

• M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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